

## V-Band Balance Mixer

RF:50-75 GHz/LO:50-75 GHz/IF:DC-25 GHz

Model: TLBM-050075-25-15

TLBM-050075-25-15 is a V-Band balance mixer. The mixer supports the full waveguide band operation for both LO and RF frequency from 50 to 75 GHz with an extremely broad IF output from DC to 25 GHz. The mixer offers a conversion loss of -10 dB typical@IF=100MHz and LO input power of 18 dBm typical.

### Features:

- Low LO Power Requirement
- Balance mixer
- Compact Package

### Applications:

- Radar Systems
- Communication Systems
- Test Equipment

## 电气特性 Electrical Characteristics:

参数 Parameter	Min	Typ	Max	单位 Units
RF频率 RF Frequency	50		75	GHz
LO频率 LO Frequency	50		75	GHz
IF频率 IF Frequency	DC		25	GHz
LO 驱动功率 LO-Input power	16	18	20	dBm
单边带变频损耗 SSB Conversion Loss	@IF=100MHz	-10		dB
	@LO=50GHz	-11		dB

## 机械特性 Mechanical Specifications:

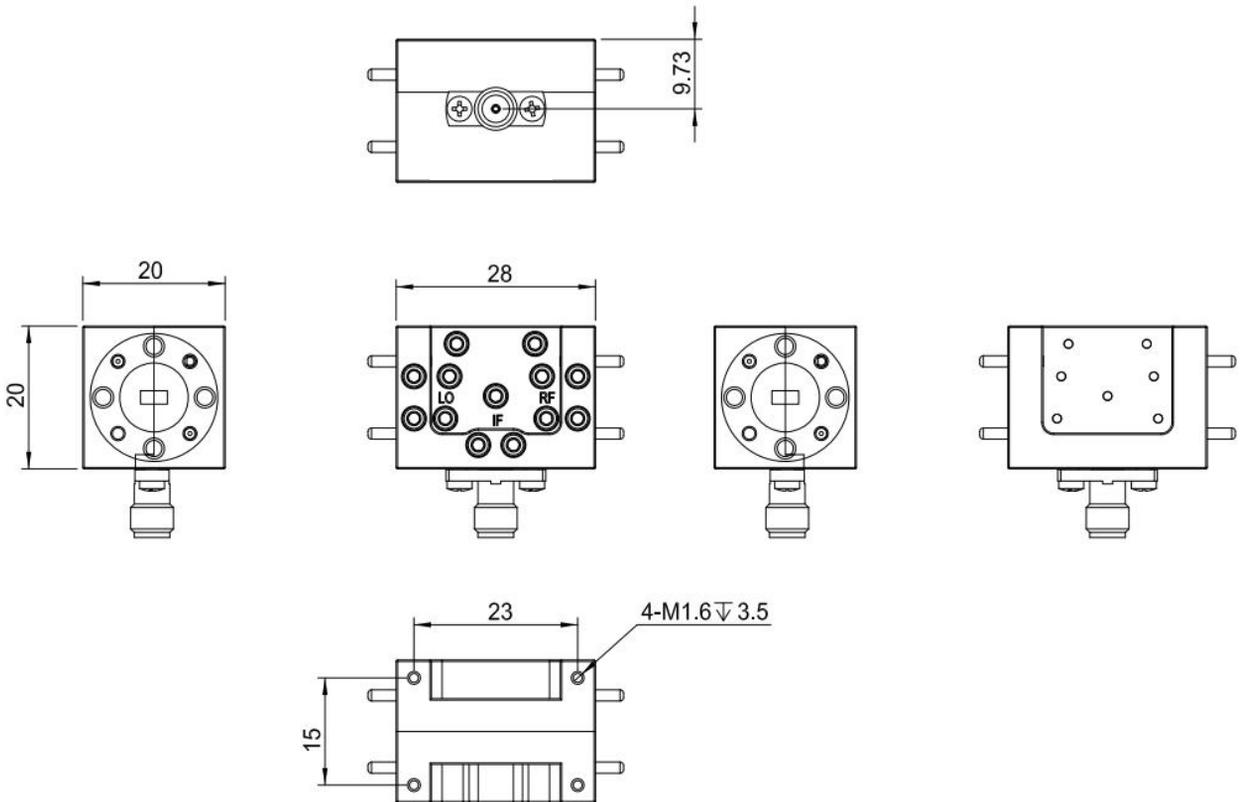
参数 Parameter	指标 Value	单位 Units
RF 接口 RF Connector	WR-15/UG-385/U	
LO 接口 LO Connector	WR-15/UG-385/U	
IF 接口 IF Connector	2.92mm Female	

## 绝对最大值 Absolute Maximum Ratings:

参数 Parameter	指标 Value
RF 功率 RF Input Power	15 dBm
IF 功率 IF Input Power	15 dBm
LO 功率 LO Input Power	21 dBm
ESD灵敏度 ESD sensitivity (HBm)	Class 0, passed 150V

## 外形图 Outline Drawing:

Unit:mm



### 温度环境 Environmental Conditions:

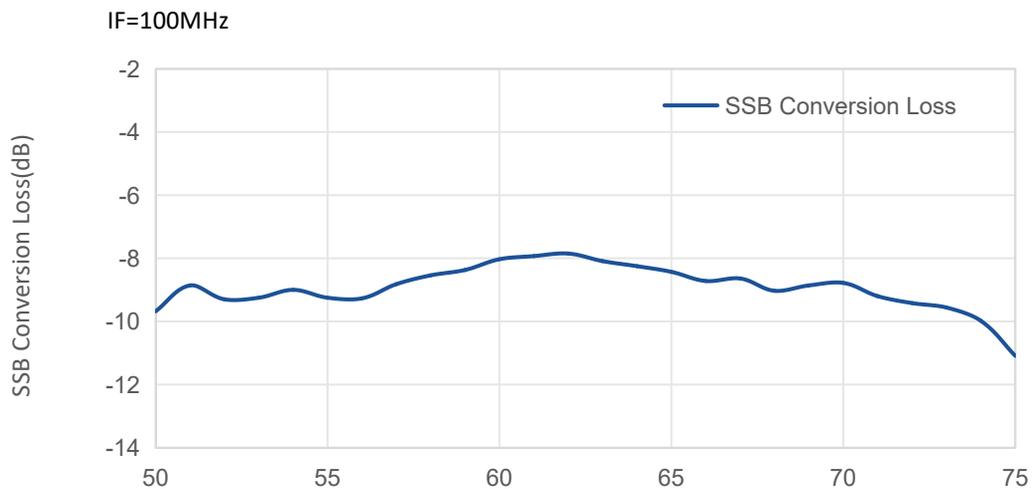
参数 Parameter	Min	Typ	Max	单位 Units
操作温度 Operating Temperature	-10		+65	°C
存储温度 Non-operating Temperature	-45		+85	°C
相对湿度 Relative humidity		95		%
海拔 Altitude	10,000			feet
震动 Shock / Vibration(MIL-STD-810F)	25g rms (15 degree 2KHz) endurance, 1 hour per axis			
冲击 Shock(non operating)	20G for 11msc half sin wave,3 axis both directions			

### 订货信息 Ordering Information:

标准型号 Base Number	描述 Description	版本号 Revision
TLBM-050075-25-15	V-Band Balance Mixer RF:50-75GHz,LO:50-75GHz,IF:DC-25GHz	Rev.1.1

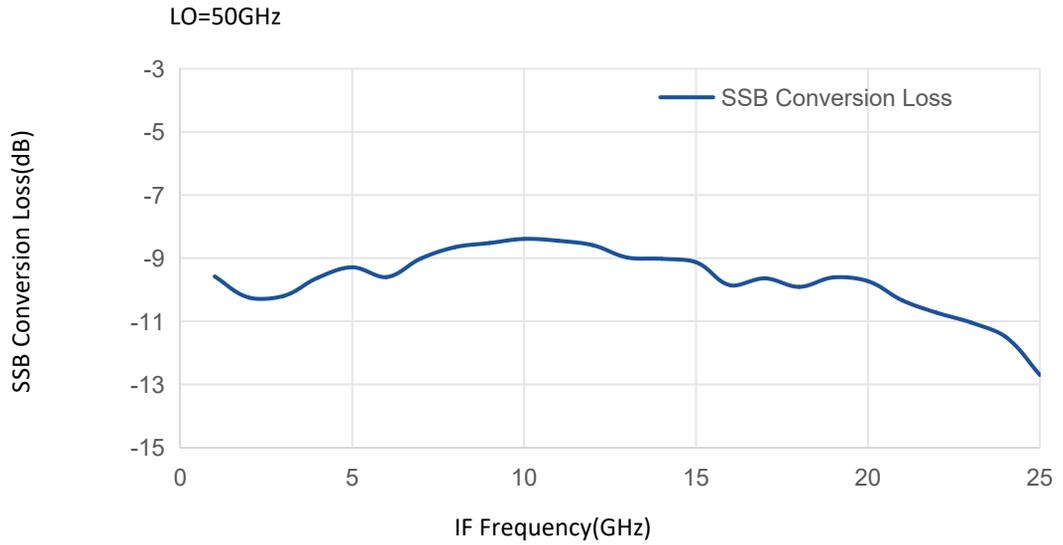
### 典型曲线 Typical Performance Data:

SSB Conversion Loss vs RF Frequency



## 典型曲线 Typical Performance Data:

### SSB Conversion Loss vs IF Frequency



Note: Above data is for ref only, actual data may vary from unit to unit depending on operating environment and other factors like material lots etc.